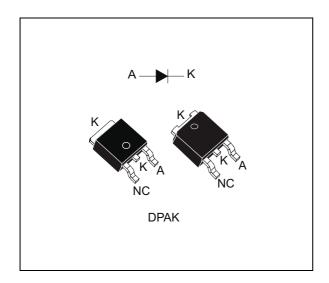


Low drop power Schottky rectifier

Datasheet - production data

www.st.com



Features

- Very low forward voltage drop for less power dissipation and reduced heatsink
- Optimized conduction/reverse losses trade-off which means the highest efficiency in the applications
- High power surface mount miniature package
- Avalanche specification

This is information on a product in full production.

 ECOPACK[®]2 compliant component for DPAK on demand

Description

Single Schottky rectifier suited for switch mode power supply and high frequency DC to DC converters.

Packaged in DPAK, this device is intended for use as a rectifier at the secondary of 3.3 V SMPS units.

Table 1. Device summary

Symbol	Value
I _{F(AV)}	5 A
V_{RRM}	25 V
T _{j (max)}	150 °C
V _{F(typ)}	0.31 V

Characteristics STPS5L25

1 Characteristics

Table 2. Absolute ratings (limiting values, at 25 °C unless otherwise stated)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage	25	V	
I _{F(RMS)}	Forward rms current	7	Α	
I _{F(AV)}	Average forward current, δ = 0.5 square wave T_c = 140 °C,		5	Α
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$		75	Α
P _{ARM}	Repetitive peak avalanche power	215	W	
T _{stg}	Storage temperature range	-65 to +150	°C	
T _j	Maximum operating junction temperature ⁽¹⁾	150	°C	

^{1.} $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Max. value	Unit
R _{th(j-c)}	Junction to case	2.5	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾ Reverse leakage current	Poverse leakage current	T _j = 25 °C	\/ _\/	-	-	350	μΑ
	T _j = 125 °C	$V_R = V_{RRM}$	-	55	115	mA	
V _F ⁽¹⁾ Forward voltage drop		T _j = 25 °C	I _F = 5 A	-	-	0.47	
	Forward voltage drop	T _j = 125 °C		-	0.31	0.35	V
	Tolward voltage drop	T _j = 25 °C	I _F = 10 A	-	-	0.59	, v
		T _j = 125 °C		-	0.41	0.50	

^{1.} Pulse test: $t_p = 380 \mu s$, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 0.2 \text{ x I}_{F(AV)} + 0.03 \text{ x I}_{F^{2}(RMS)}$$

STPS5L25 Characteristics

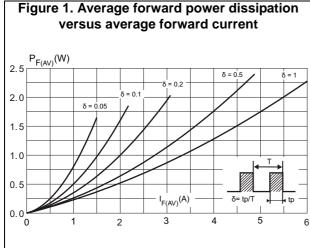
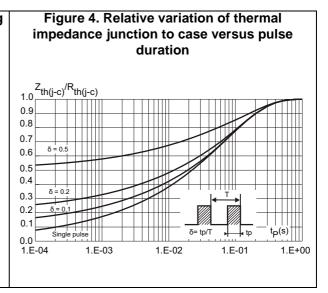
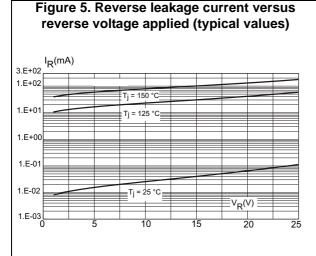
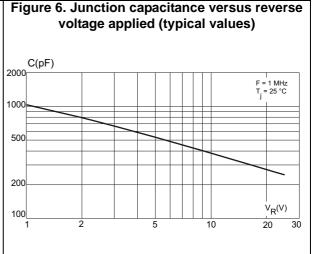


Figure 2. Average forward current versus ambient temperature (δ = 0.5) $I_{F(AV)}(A)$ 6 $R_{th(j-a)}^{I} = R_{th(j-c)}^{I}$ 5 4 R_{th(j-a)}= 70 °C/W 3 2 T_{amb}(°C) 0 0 50 75 100 125 150

Figure 3. Normalized avalanche power derating versus pulse duration at T_j = 125 °C



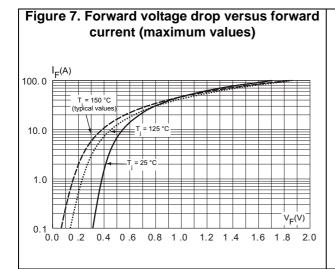


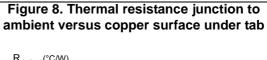


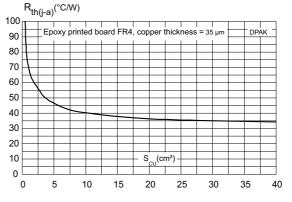
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2 Package Information

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

2.1 DPAK package information

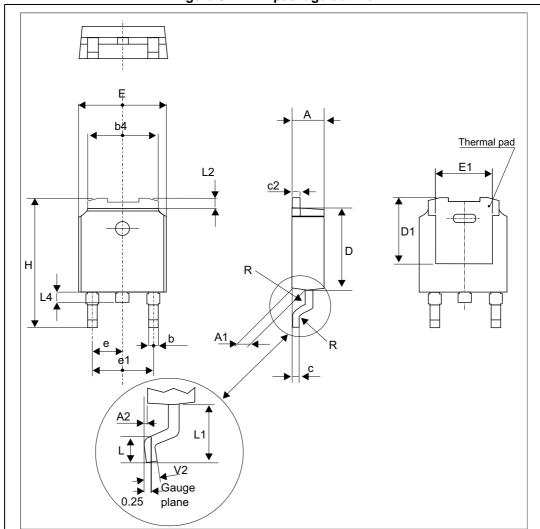


Figure 9. DPAK package outline

Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.



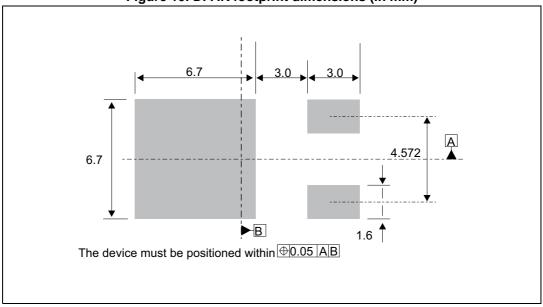
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Package Information STPS5L25

Table 5. DPAK package mechanical data

			·	Dimensions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	2.18		2.40	0.085		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
b	0.64		0.90	0.025		0.035
b4	4.95		5.46	0.194		0.214
С	0.46		0.61	0.018		0.024
c2	0.46		0.60	0.018		0.023
D	5.97		6.22	0.235		0.244
D1	4.95		5.60	0.194		0.220
Е	6.35		6.73	0.250		0.264
E1	4.32		5.50	0.170		0.216
е		2.28			0.090	
e1	4.40		4.70	0.173		0.185
Н	9.35		10.40	0.368		0.409
L	1.00		1.78	0.039		0.070
L2			1.27			0.050
L4	0.60		1.02	0.023		0.040
V2	-8°		+8°	-8°		8°

Figure 10. DPAK footprint dimensions (in mm)



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3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS5L25B-TR	STPS5 L25B	DPAK	0.32 g	2500	Tape and reel

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
Jul-2003	5A	Previous release.
15-Apr-2008	6	Reformatted to current standard. Corrected order code in <i>Table 5</i> .
08-Jan-2015	7	Updated package information and reformatted to current standard.
15-May-2017	8	Updated DPAK package information and reformatted to current standard.

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